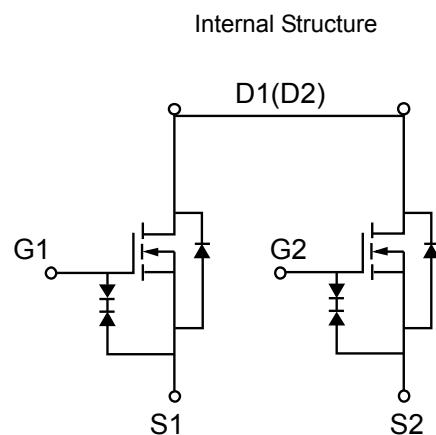
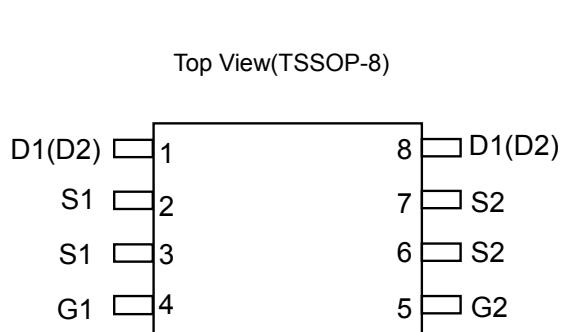


## Description

The MOSFET provide the best combination of fast switching, low on-resistance and cost-effectiveness.

MOSFET Product Summary		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (mΩ)	I <sub>D</sub> (A)
20	16@ V <sub>GS</sub> =4.5V	7



## Absolute maximum rating@25°C

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V <sub>DS</sub>	20	V
Gate-Source Voltage	V <sub>GS</sub>	±12	V
Continuous Drain Current Current(T <sub>J</sub> =150°C)	I <sub>D</sub>	7	A
T <sub>A</sub> =70°C	4.6		
Pulsed Drain Current	I <sub>DM</sub>	60	A
Maximum Power Dissipation	P <sub>D</sub>	1.3	W
T <sub>A</sub> =70°C	0.8		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

## Thermal Characteristics

Parameter	Symbol	Typical	Maximum	Units
Maximum Junction-to-Ambient	R <sub>θJA</sub>	76	95	°C/W
Maximum Junction-to-Ambient		118	150	°C/W
Maximum Junction-to-Lead	R <sub>θJL</sub>	54	68	°C/W

## Electrical characteristics per line@25°C( unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA,V <sub>GS</sub> =0V	20		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V,V <sub>GS</sub> =±10V	-	-	±10	μA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.5	0.75	1.0	V
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =7A		16	20	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =5A		20	24	
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =2A		23	35	
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =10V, I <sub>D</sub> =7.0A		16.2	21	nC
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, I <sub>D</sub> =7.0A		7.7	10	
Gate-Source Charge	Q <sub>gs</sub>			1.5		
Gate-Drain Charge	Q <sub>gd</sub>			2.7		
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =10V, f=1MHz	-	620	780	pF
Output Capacitance	C <sub>oss</sub>		-	125		pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	64		pF
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DS</sub> =10V, R <sub>GEN</sub> =3Ω, V <sub>GS</sub> =10V,R <sub>L</sub> =1.7Ω	-	236		ns
Turn-Off Delay Time	t <sub>d(off)</sub>		-	9.5		μs
Turn-On Rise Time	t <sub>r</sub>		-	448		ns
Turn-On Fall Time	t <sub>f</sub>		-	4.1		μs
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =7A,dI/dt=100A/μs		25	33	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> =7A,dI/dt=100A/μs		9		nC
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =1.0A		0.65	1.0	V
Maximum Body-Diode Continuous Current	I <sub>S</sub>				1.3	A

## Typical Characteristics

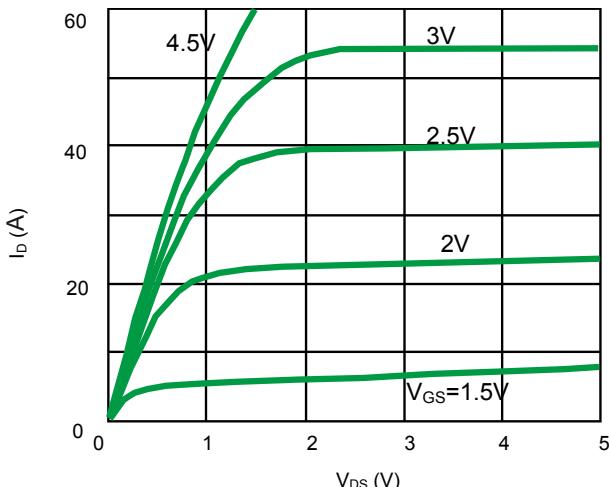


Fig 1. On-Region Characteristics

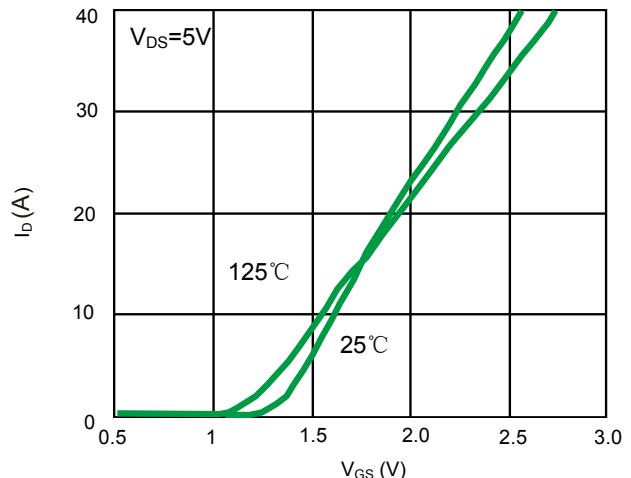


Fig 2. Transfer Characteristics

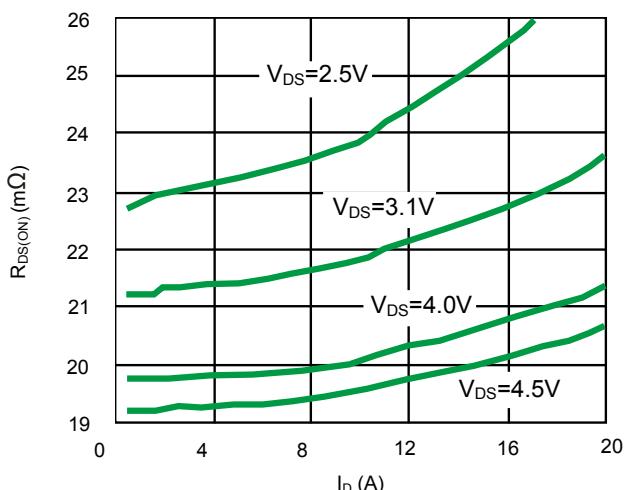


Fig 3. On-Resistance vs. Drain Current and gate Voltage

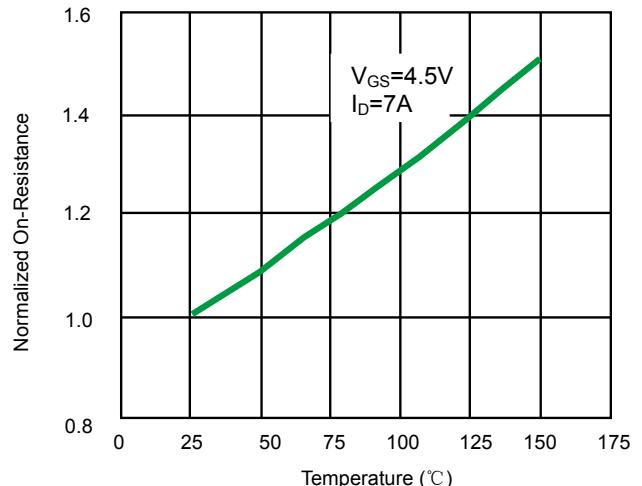


Fig 4. On-Resistance vs. Junction Temperature

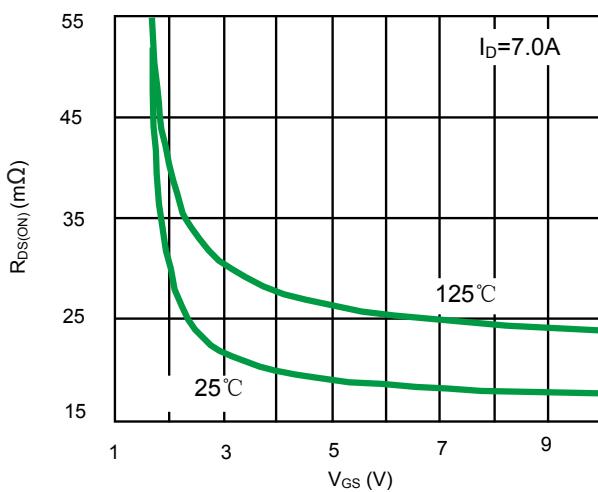


Fig 5. On-Resistance vs. Gate-Source Voltage

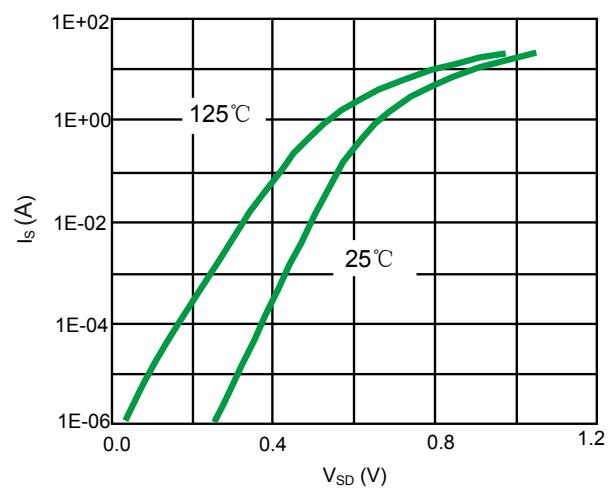


Fig 6. Body-Diode Characteristics

## Dual N-Channel MOSFET

PDNM8TP20V7E

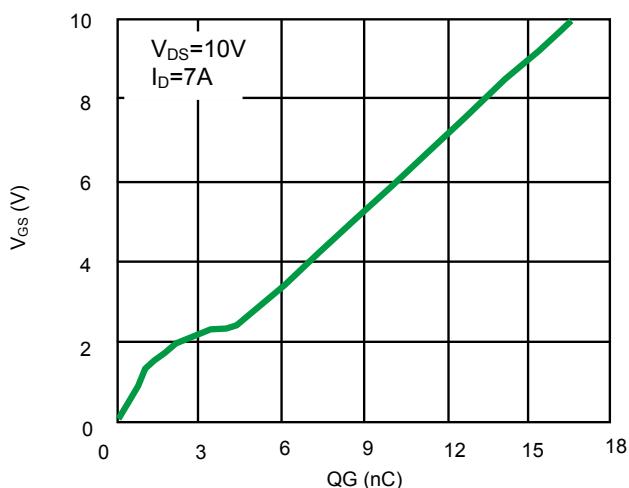


Fig 7. Gate Charge Characteristics

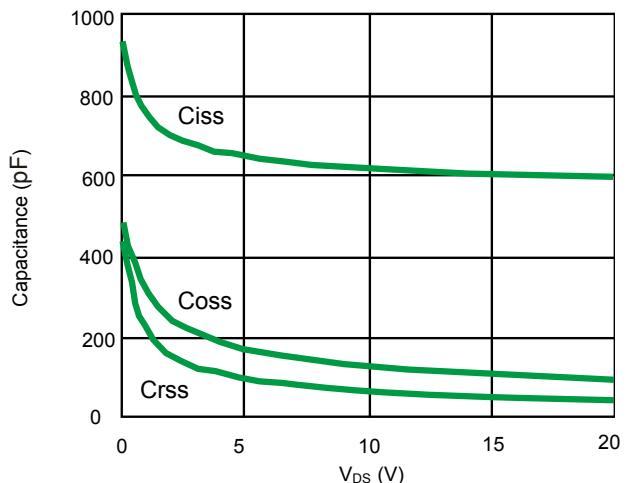


Fig 8. Capacitance Characteristics

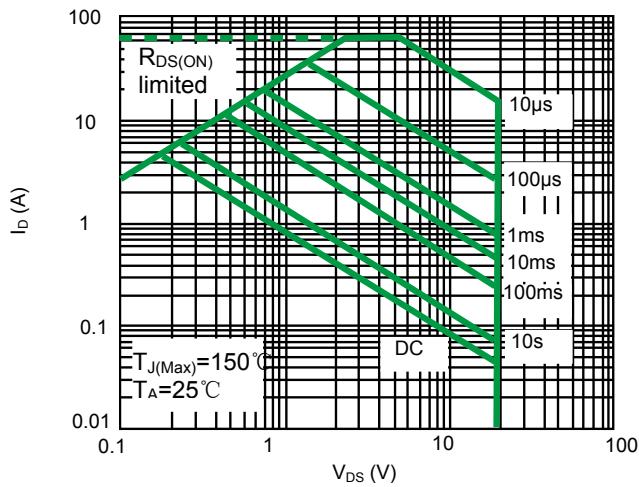


Fig 9. Maximum Forward Biased Safe Operating Area

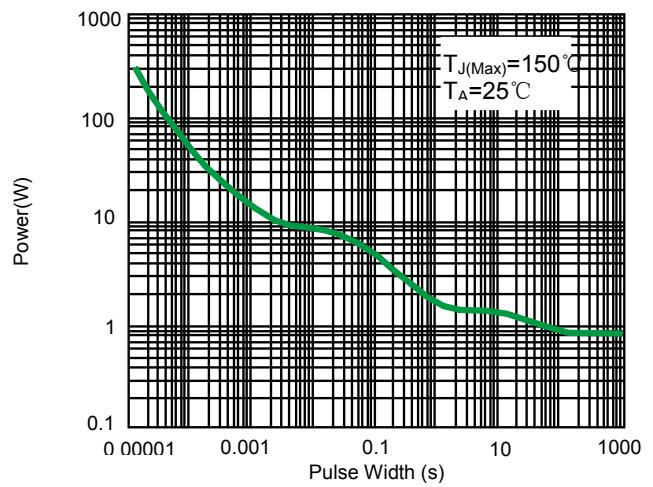


Fig 10. Single Pulse Power Rating Junction-to-Ambient

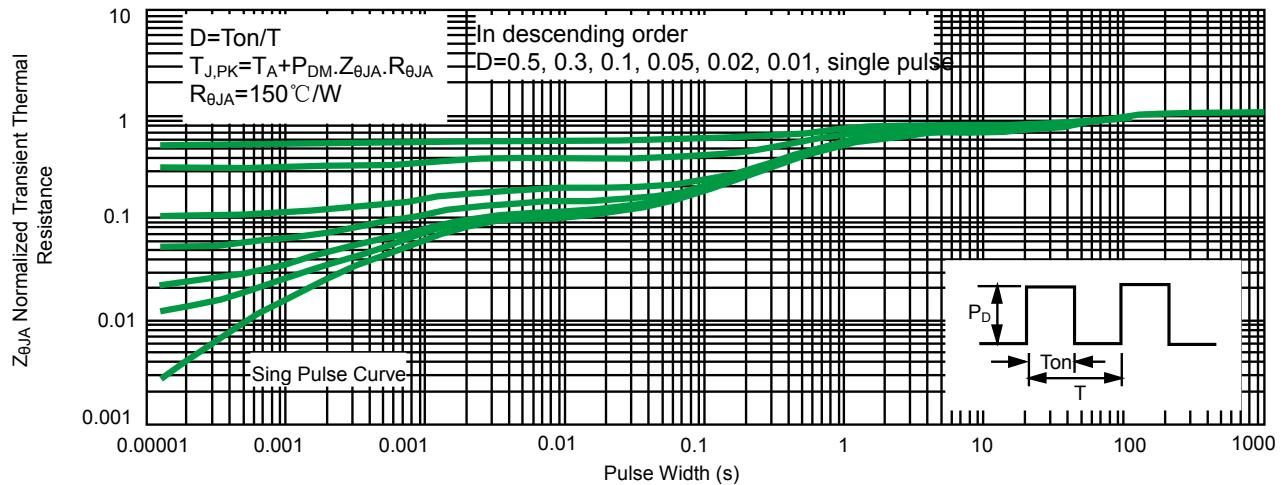
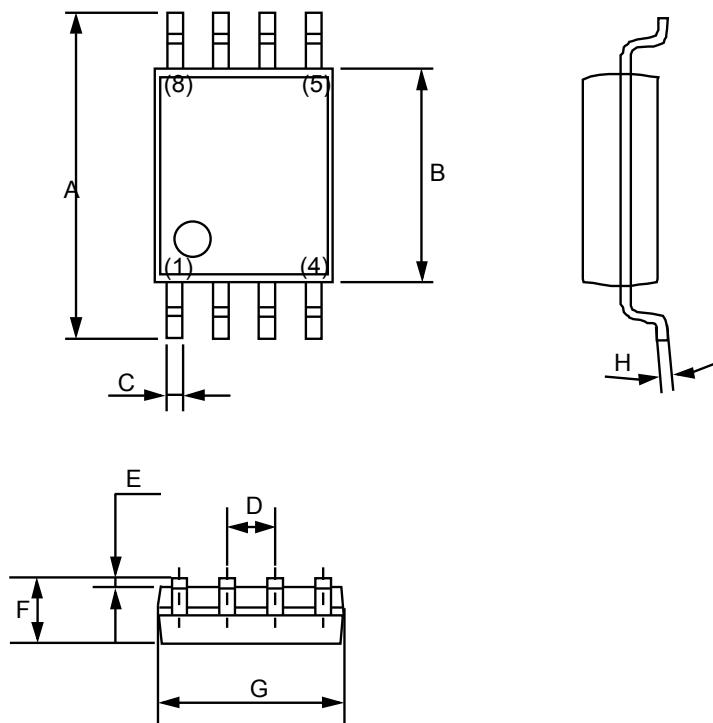


Fig 11. Normalized Maximum Transient Thermal Impedance

## Product dimension(TSSOP-8)



Dim	Millimeters		Inches	
	MIN	MAX	MIN	MAX
A	6.250	6.550	0.246	0.258
B	4.300	4.500	0.169	0.177
C	0.190	0.300	0.007	0.012
D	0.65(BSC)		0.026(BSC)	
E	0.020	0.150	0.001	0.006
F	0.800	1.000	0.031	0.039
G	2.900	3.100	0.114	0.122
H	0.090	0.200	0.004	0.008

**IMPORTANT NOTICE**

 and **Prisemi**<sup>®</sup> are registered trademarks of **Prisemi Electronics Co., Ltd (Prisemi)**, Prisemi reserves the right to make changes without further notice to any products herein. Prisemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Prisemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in Prisemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Prisemi does not convey any license under its patent rights nor the rights of others. The products listed in this document are designed to be used with ordinary electronic equipment or devices, Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

Website: <http://www.prisemi.com>

For additional information, please contact your local Sales Representative.

©Copyright 2009, Prisemi Electronics

 **Prisemi**<sup>®</sup> is a registered trademark of Prisemi Electronics.

All rights are reserved.